## 10-Bit, 40 MSPS, 3V, 55.5 mW A/D Converter

## General Description

The ADC10040 is a monolithic CMOS analog-to-digital converter capable of converting analog input signals into 10-bit digital words at 40 Megasamples per second (MSPS). This converter uses a differential, pipeline architecture with digital error correction and an on-chip sample-and-hold circuit to provide a complete conversion solution, and to minimize power consumption, while providing excellent dynamic performance. A unique sample-and-hold stage yields a full-power bandwidth of 400 MHz . Operating on a single 3.0V power supply, this device consumes just 55.5 mW at 40 MSPS, including the reference current. The Standby feature reduces power consumption to just 13.5 mW .
The differential inputs provide a full scale selectable input swing of $2.0 \mathrm{~V}_{\mathrm{P}_{-P}, 1.5 \mathrm{~V}_{\text {P-P }}, 1.0 \mathrm{~V}_{\text {P-P }} \text {, with the possibility of a }}$ single-ended input. Full use of the differential input is recommended for optimum performance. An internal +1.2 V precision bandgap reference is used to set the ADC full-scale range, and also allows the user to supply a buffered referenced voltage for those applications requiring increased accuracy. The output data format is user choice of offset binary or two's complement.
The ADC10040Q runs on an Automotive Grade Flow and is AEC-Q100 Grade 3 Qualified.
This device is available in the 28 -lead TSSOP package and will operate over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## Features

- Single +3.0 V operation
- Selectable 2.0 $\mathrm{V}_{\text {P-P }}, 1.5 \mathrm{~V}_{\text {P-P }}$, or $1.0 \mathrm{~V}_{\text {P-P }}$ full-scale input swing
- $400 \mathrm{MHz}-3 \mathrm{~dB}$ input bandwidth
- Low power consumption
- Standby mode
- On-chip reference and sample-and-hold amplifier
- Offset binary or two's complement data format
- Separate adjustable output driver supply to accommodate 2.5 V and 3.3 V logic families
- AEC-Q100 Grade 3 Qualified
- 28-pin TSSOP package


## Key Specifications

## - Resolution

10 Bits

- Conversion Rate
- Full Power Bandwidth 40 MSPS
- DNL 400 MHz
- $\operatorname{SNR}\left(\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}\right)$ $\pm 0.3$ LSB (typ)
- $\operatorname{SFDR}\left(\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}\right)$ 59.6 dB (typ)
- Power Consumption, 40 MHz
-80 dB (typ)


## Applications

- Ultrasound and Imaging
- Instrumentation
- Cellular Base Stations/Communications Receivers
- Sonar/Radar
- xDSL
- Wireless Local Loops
- Data Acquisition Systems
- DSP Front Ends


## Connection Diagram



## Ordering Information

| Industrial (-40 $\left.\mathbf{C} \leq \mathbf{T}_{\mathbf{A}} \leq+\mathbf{8 5}^{\circ} \mathbf{C}\right)$ | NS Package | Top Mark | Features |
| :---: | :---: | :---: | :---: |
| ADC10040CIMT | 28 Pin TSSOP | ADC10040CIMT |  |
| ADC10040CIMTX | 28 Pin TSSOP Tape \& Reel | ADC10040CIMT |  |
| ADC10040QCIMTX | 28 Pin TSSOP | ADC10040QCIMT | AEC-Q100 Grade 3 Qualified. <br> Automotive Grade Production Flow |
| ADC10040QCIMTX | 28 Pin TSSOP Tape \& Reel | ADC10040QCIMT | AEC-Q100 Grade 3 Qualified. <br> Automotive Grade Production Flow |
| Use ADC10080EVAL | Evaluation Board | $\mathrm{n} / \mathrm{a}$ |  |

## Block Diagram



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## Pin Descriptions and Equivalent Circuits

| Pin No. | Symbol | Equivalent Circuit | Description |
| :---: | :---: | :---: | :---: |
| ANALOG I/O |  |  |  |
| 12 | $\mathrm{V}_{\text {IN- }}$ |  | Inverting analog input signal. With a 1.2 V reference the full-scale input signal level is a differential $1.0 \mathrm{~V}_{\mathrm{P}-\mathrm{p}}$. This pin may be tied to $\mathrm{V}_{\text {COM }}$ (pin 4) for single-ended operation. |
| 13 | $\mathrm{V}_{1 \mathrm{~N}^{+}}$ |  | Non-inverting analog input signal. With a 1.2 V reference the fullscale input signal level is a differential $1.0 \mathrm{~V}_{\text {P-P }}$. |
| 6 | $\mathrm{V}_{\text {REF }}$ |  | Reference Voltage. This device provides an internal 1.2V reference. This pin should be bypassed to $\mathrm{V}_{\text {SSA }}$ with a $0.1 \mu \mathrm{~F}$ monolithic capacitor. $\mathrm{V}_{\text {REF }}$ is 1.20 V nominal. This pin may be driven by a 1.20 V external reference if desired. Do not load this pin. |
| 7 4 8 | $V_{\text {REFT }}$ <br> $\mathrm{V}_{\text {Сом }}$ <br> $V_{\text {REFB }}$ |  | These pins are high impedance reference bypass pins only. Connect a $0.1 \mu \mathrm{~F}$ capacitor from each of these pins to $\mathrm{V}_{\text {SSA }}$. These pins should not be loaded. $\mathrm{V}_{\text {Сом }}$ may be used to set the input common mode voltage $\mathrm{V}_{\mathrm{CM}}$. |

DIGITAL I/O

| 1 | CLK |  | Digital clock input. The range of frequencies for this input is 20 MHz to 40 MHz . The input is sampled on the rising edge of this input. |
| :---: | :---: | :---: | :---: |
| 15 | DF |  | DF = "1" Two's Complement DF = " 0 " Offset Binary |
| 28 | STBY |  | This is the standby pin. When high, this pin sets the converter into standby mode. When this pin is low, the converter is in active mode. |
| 5 | IRS (Input Range Select) |  | IRS = "V VDA " $2.0 \mathrm{~V}_{\text {P-P }}$ input range <br> IRS = "V VSA " $1.5 \mathrm{~V}_{\text {P-P }}$ input range <br> IRS = "Floating" $1.0 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ input range <br> If using both $\mathrm{V}_{\mathrm{IN}^{+}}$and $\mathrm{V}_{\mathrm{IN}^{-}}$pins, (or differential mode), then the peak-to-peak voltage refers to the differential voltage $\left(\mathrm{V}_{I N^{+}}-\mathrm{V}_{I N^{-}}\right)$. |



## Absolute Maximum Ratings <br> (Note 1, Note

2) 

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

| V $_{\text {DDA }}$, V $_{\text {DDIO }}$ | 3.9 V |
| :--- | ---: |
| Voltage on Any Pin to GND | -0.3 V to $\mathrm{V}_{\text {DDA }}$ or |
|  | $\mathrm{V}_{\text {DDIO }}+0.3 \mathrm{~V}$ |
| Input Current on Any Pin | $\pm 25 \mathrm{~mA}$ |
| Package Input Current (Note 3) | $\pm 50 \mathrm{~mA}$ |
| Package Dissipation at T $=25^{\circ} \mathrm{C}$ | See (Note 4) |
| ESD Susceptibility |  |
| $\quad$ Human Body Model (Note 5) | 2500 V |
| $\quad$ Machine Model (Note 5) | 250 V |
| Soldering Temperature |  |
| $\quad$ Infrared, 10 sec. (Note 6) | $235^{\circ} \mathrm{C}$ |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

Operating Ratings (Note 1, Note 2)

| Operating Temperature Range | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |
| :--- | ---: |
| $\mathrm{V}_{\text {DDA }}$ (Supply Voltage) | +2.7 V to +3.6 V |
| $\mathrm{~V}_{\text {DDIO }}$ (Output Driver Supply |  |
| Voltage) | +2.5 V to $\mathrm{V}_{\mathrm{DDA}}$ |
| $\mathrm{V}_{\text {REF }}$ | 1.20 V |
| IV $_{\text {SSA }}-\mathrm{V}_{\text {SSIO }}$ | $\leq 100 \mathrm{mV}$ |
| Clock Duty Cycle | 30 to $70 \%$ |

## Converter Electrical Characteristics

Unless otherwise specified, the following specifications apply for $\mathrm{V}_{\text {SSA }}=\mathrm{V}_{\text {SSIO }}=0 \mathrm{~V}, \mathrm{~V}_{\text {DDA }}=+3.0 \mathrm{~V}, \mathrm{~V}_{\text {DDIO }}=+2.5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=2 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$, $\mathrm{STBY}=0 \mathrm{~V}$, External $\mathrm{V}_{\text {REF }}=1.20 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, 50 \%$ Duty Cycle, $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} / \mathrm{pin}$. Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to
$\mathbf{T}_{\text {MAX }}$ : all other limits $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 9, Note 10, Note 11)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC CONVERTER CHARACTERISTICS |  |  |  |  |  |  |
|  | No Missing Codes Guaranteed |  | 10 |  |  | Bits |
| INL | Integral Non-Linearity | $\mathrm{F}_{\mathrm{IN}}=250 \mathrm{kHz},-0 \mathrm{~dB} \text { Full }$ <br> Scale | -1.0 | $\pm 0.3$ | +1.0 | LSB |
| DNL | Differential Non-Linearity | $\mathrm{F}_{\mathrm{IN}}=250 \mathrm{kHz},-0 \mathrm{~dB}$ Full Scale | -0.9 | $\pm 0.3$ | +0.9 | LSB |
| GE | Gain Error | Positive Error | -1.5 | +0.4 | +1.9 | \% FS |
|  |  | Negative Error | -1.5 | -0.01 | +1.9 | \% FS |
| OE | Offset Error ( $\left.\mathrm{V}_{\mathrm{IN}^{+}}=\mathrm{V}_{\text {IN }}{ }^{-}\right)$ |  | -1.4 | 0.12 | +1.6 | \% FS |
|  | Under Range Output Code |  |  | 0 |  |  |
|  | Over Range Output Code |  |  | 1023 |  |  |
| FPBW | Full Power Bandwidth (Note 16) |  |  | 400 |  | MHz |

## REFERENCE AND INPUT CHARACTERISTICS

| $\mathrm{V}_{\mathrm{CM}}$ | Common Mode Input Voltage |  | 0.5 |  | 1.5 |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{COM}}$ | Output Voltage for use as an input <br> common mode voltage (Note 8) |  |  | 1.45 | V |
| $\mathrm{~V}_{\text {REF }}$ | Reference Voltage |  |  | 1.2 |  |
| $\mathrm{~V}_{\text {REFTC }}$ | Reference Voltage Temperature <br> Coefficient |  | $\pm 80$ | V |  |
| $\mathrm{C}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}$ Input Capacitance (each pin to <br> $\left.\mathrm{V}_{\text {SSA }}\right)$ |  | 4 | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |  |

POWER SUPPLY CHARACTERISTICS

| $\mathrm{I}_{\text {VDDA }}$ | Analog Supply Current | STBY = 1 | 4.5 | 6.0 | mA |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | STBY $=0$ | 18 | 25 | mA |
| $\mathrm{I}_{\text {vDdio }}$ | Digital Supply Current (Note 14) | STBY $=1, \mathrm{f}_{\text {IN }}=0 \mathrm{~Hz}$ | 0 |  | mA |
|  |  | STBY $=0, \mathrm{f}_{\text {IN }}=0 \mathrm{~Hz}$ | 0.6 | 0.8 | mA |
| PWR | Power Consumption (Note 15) | STBY $=1$ | 13.5 | 18 | mW |
|  |  | STBY $=0$ | 55.5 | 77 | mW |

DC and Logic Electrical Characteristics Unless otherwise specified, the following specifications apply for $\mathrm{V}_{\mathrm{SSA}}=\mathrm{V}_{\text {SSIO }}=0 \mathrm{~V}, \mathrm{~V}_{\text {DDA }}=+3.0 \mathrm{~V}, \mathrm{~V}_{\text {DDIO }}=+2.5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=2 \mathrm{~V}_{\mathrm{P} . \mathrm{P}}, \mathrm{STBY}=0 \mathrm{~V}$, External $\mathrm{V}_{\text {REF }}=1.20 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, 50 \%$ Duty Cycle, $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} /$ pin. Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MII }}$ to $\mathrm{T}_{\text {MAx }}$ : all other limits $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 9, Note 10, Note 11)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CLK, DF, STBY, SENSE |  |  |  |  |  |  |
|  | Logical "1" Input Voltage |  | 2 |  |  | V |
|  | Logical "0" Input Voltage |  |  |  | 0.8 | V |
|  | Logical "1" Input Current |  |  |  | +10 | $\mu \mathrm{A}$ |
|  | Logical "0" Input Current |  | -10 |  |  | $\mu \mathrm{A}$ |

## D0-D9 OUTPUT CHARACTERISTICS

|  | Logical "1" Output Voltage | $\mathrm{I}_{\text {OUT }}=-0.5 \mathrm{~mA}$ | $\mathrm{~V}_{\text {DDIO }}-\mathbf{0 . 2}$ |  |  | V |
| :--- | :--- | :--- | :--- | :--- | :---: | :---: |
|  | Logical "0" Output Voltage | $\mathrm{I}_{\text {OUT }}=1.6 \mathrm{~mA}$ |  |  | $\mathbf{0 . 4}$ | V |

DYNAMIC CONVERTER CHARACTERISTICS (Note 13)

| ENOB | Effective Number of Bits | $\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}$ | $\begin{aligned} & 9.4, \\ & 9.3 \end{aligned}$ | 9.6 | Bits |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{f}_{\mathrm{IN}}=19 \mathrm{MHz}$ | $\begin{aligned} & 9.4, \\ & 9.3 \end{aligned}$ | 9.6 | Bits |
| SNR | Signal-to-Noise Ratio | $\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}$ | $\begin{gathered} 58.7, \\ 58.1 \end{gathered}$ | 59.6 | dB |
|  |  | $\mathrm{f}_{\mathrm{IN}}=19 \mathrm{MHz}$ | $\begin{gathered} 58.6, \\ 58 \end{gathered}$ | 59.5 | dB |
| SINAD | Signal-to-Noise Ratio + Distortion | $\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}$ | $\begin{gathered} 58.6, \\ 58 \end{gathered}$ | 59.5 | dB |
|  |  | $\mathrm{f}_{\mathrm{IN}}=19 \mathrm{MHz}$ | $\begin{gathered} 58.5, \\ 57.8 \end{gathered}$ | 59.4 | dB |
| 2nd HD | 2nd Harmonic | $\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}$ | $\begin{aligned} & -75.9, \\ & -74.7 \end{aligned}$ | -89 | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=19 \mathrm{MHz}$ | $\begin{gathered} \hline-74.4, \\ -73 \end{gathered}$ | -86 | dBc |
| 3 rd HD | 3rd Harmonic | $\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}$ | $\begin{aligned} & \hline-69.5, \\ & -67.5 \end{aligned}$ | -78 | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=19 \mathrm{MHz}$ | $\begin{aligned} & -68.8, \\ & -66.7 \end{aligned}$ | -77 | dBc |
| THD | Total Harmonic Distortion (First 6 Harmonics) | $\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}$ | $\begin{aligned} & -69.5 \\ & -67.5 \end{aligned}$ | -78 | dB |
|  |  | $\mathrm{f}_{.1 \mathrm{~N}}=19 \mathrm{MHz}$ | $\begin{aligned} & -68.8, \\ & -66.7 \end{aligned}$ | -77 | dB |
| SFDR | Spurious Free Dynamic Range (Excluding 2nd and 3rd Harmonic) | $\mathrm{f}_{\mathrm{IN}}=11 \mathrm{MHz}$ | $\begin{aligned} & \hline-75.8, \\ & -74.5 \end{aligned}$ | -80 | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=19 \mathrm{MHz}$ | $\begin{aligned} & -75.7, \\ & -74.3 \end{aligned}$ | -80 | dBc |

## AC Electrical Characteristics

Unless otherwise specified, the following specifications apply for $\mathrm{V}_{\text {SSA }}=\mathrm{V}_{\mathrm{SSIO}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDA}}=+3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDIO}}=+2.5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=$ $2 \mathrm{~V}_{\text {P-P }}$ (full scale), $\mathrm{STBY}=0 \mathrm{~V}$, External $\mathrm{V}_{\text {REF }}=1.20 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, 50 \%$ Duty Cycle, $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} / \mathrm{pin}$. Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ : all other limits $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 10, Note 11, Note 12)

| Symbol | Parameter | Conditions | $\begin{gathered} \operatorname{Min} \\ (\text { Note 12) } \end{gathered}$ | $\begin{gathered} \text { Typ } \\ (\text { Note 12) } \end{gathered}$ | $\begin{array}{c\|} \hline \text { Max } \\ (\text { Note 12) } \end{array}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CLK, DF, STBY, SENSE |  |  |  |  |  |  |
| ${ }_{\text {CLK }}{ }^{1}$ | Maximum Clock Frequency |  |  |  | 40 | MHz (min) |
| $\mathrm{f}_{\text {CLK }}{ }^{2}$ | Minimum Clock Frequency |  |  | 20 |  | MHz |
| $\mathrm{t}_{\mathrm{CH}}$ | Clock High Time |  |  | 12.5 |  | ns |
| $\mathrm{t}_{\mathrm{CL}}$ | Clock Low Time |  |  | 12.5 |  | ns |
| $\mathrm{t}_{\text {conv }}$ | Conversion Latency |  |  |  | 6 | Cycles |
| $\mathrm{t}_{\mathrm{OD}}$ | Data Output Delay after a Rising Clock Edge | $\mathrm{T}=25^{\circ} \mathrm{C}$ | 2 | 3.3 | 5 | ns |
|  |  |  | 1 |  | 6 | ns |
| $\mathrm{t}_{\mathrm{AD}}$ | Aperture Delay |  |  | 1 |  | ns |
| $\mathrm{t}_{\mathrm{AJ}}$ | Aperture Jitter |  |  | 2 |  | ps (RMS) |
|  | Over Range Recovery Time | Differential $\mathrm{V}_{\text {IN }}$ step from $\pm 3 \mathrm{~V}$ to 0 V to get accurate conversion |  | 1 |  | Clock Cycle |
| $\mathrm{t}_{\text {STBY }}$ | Standby Mode Exit Cycle |  |  | 20 |  | Cycles |

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
Note 2: All voltages are measured with respect to $G N D=V_{S S A}=V_{S S I O}=0 V$, unless otherwise specified.
Note 3: When the voltage at any pin exceeds the power supplies $\left(V_{I N}<V_{S S A}\right.$ or $\left.V_{I N}>V_{D D A}\right)$, the current at that pin should be limited to 25 mA . The 50 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 25 mA to two.
Note 4: The absolute maximum junction temperature ( $T_{J} \max$ ) for this device is $150^{\circ} \mathrm{C}$. The maximum allowable power dissipation is dictated by $T_{J} m a x$, the junction-to-ambient thermal resistance ( $\theta_{J A}$ ), and the ambient temperature $\left(T_{A}\right)$, and can be calculated using the formula $P_{D} M A X=\left(T_{J} m a x-T_{A}\right) / \theta_{\mathrm{JA}}$. In the 28pin TSSOP, $\theta_{\mathrm{JA}}$ is $96^{\circ} \mathrm{C} / \mathrm{W}$, so $\mathrm{P}_{\mathrm{D}} \mathrm{MAX}=1,302 \mathrm{~mW}$ at $25^{\circ} \mathrm{C}$ and 677 mW at the maximum operating ambient temperature of $85^{\circ} \mathrm{C}$. Note that the power dissipation of this device under normal operation will typically be about 55.5 mW . The values for maximum power dissipation listed above will be reached only when the ADC10040 is operated in a severe fault condition.
Note 5: Human body model is 100 pF capacitor discharged through a $1.5 \mathrm{k} \Omega$ resistor. Machine model is 220 pF discharged through $0 \Omega$
Note 6: The $235^{\circ} \mathrm{C}$ reflow temperature refers to infrared reflow. For Vapor Phase Reflow (VPR) the following conditions apply: Maintain the temperature at the top of the package body above $183^{\circ} \mathrm{C}$ for a minimum of 60 seconds. The temperature measured on the package body must not exceed $220^{\circ} \mathrm{C}$. Only one excursion above $183^{\circ} \mathrm{C}$ is allowed per reflow cycle.

Note 7: The analog inputs are protected as shown below. Input voltage magnitude up to 500 mV beyond the supply rails will not damage this device. However, input errors will be generated if the input goes above $\mathrm{V}_{\mathrm{DDA}}$ or $\mathrm{V}_{\mathrm{DDIO}}$ and below $\mathrm{V}_{\mathrm{SSA}}$ or $\mathrm{V}_{\mathrm{SSIO}}$.


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Note 8: $\mathrm{V}_{\mathrm{COM}}$ is a typical value, measured at room temperature. It is not guaranteed by test. Do not load this pin.
Note 9: To guarantee accuracy, it is required that $\mid V_{D D A}-V_{D D I O} I \leq 100 \mathrm{mV}$ and separate bypass capacitors are used at each power supply pin.
Note 10: With the test condition for $2 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ differential input, the 10 -bit LSB is 1.95 mV .
Note 11: Typical figures are at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ and represent most likely parametric norms. Test limits are guaranteed to National's AOQL (Average Outgoing Quality Level).
Note 12: Timing specifications are tested at TTL logic levels, $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ for a falling edge, and $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}$ for a rising edge.
Note 13: Optimum dynamic performance will be obtained by keeping the reference input in the +1.2 V .
Note 14: $\mathrm{V}_{\mathrm{DDIO}}$ is the current consumed by the switching of the output drivers and is primarily determined by load capacitance on the output pins, the supply voltage, $V_{D R}$, and the rate at which the outputs are switching (which is signal dependent). $I_{D R}=V_{D R} \times\left(C_{0} \times f_{0}+C_{1} \times f_{1}+C_{2}+f_{2}+\ldots . C_{11} \times f_{11}\right)$ where $V_{D R}$ is the output driver supply voltage, $\mathrm{C}_{\mathrm{n}}$ is the total load capacitance on the output pin, and $\mathrm{f}_{\mathrm{n}}$ is the average frequency at which the pin is toggling.
Note 15: Power consumption includes output driver power. ( $\mathrm{f}_{\mathbb{I}}=0 \mathrm{MHz}$ ).
Note 16: The input bandwidth is limited using a capacitor between $\mathrm{V}_{\mathrm{IN}^{-}}$and $\mathrm{V}_{\mathrm{IN}^{+}}$.

## Specification Definitions

APERTURE DELAY is the time after the rising edge of the clock to when the input signal is acquired or held for conversion.
APERTURE JITTER (APERTURE UNCERTAINTY) is the variation in aperture delay from sample to sample. Aperture jitter manifests itself as noise in the output.
COMMON MODE VOLTAGE $\left(\mathrm{V}_{\mathbf{C M}}\right)$ is the d.c. potential present at both signal inputs to the ADC.
CONVERSION LATENCY See PIPELINE DELAY.
DIFFERENTIAL NON-LINEARITY (DNL) is the measure of the maximum deviation from the ideal step size of 1 LSB .
DUTY CYCLE is the ratio of the time that a repetitive digital waveform is high to the total time of one period. The specification here refers to the ADC clock input signal.
EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS) is another method of specifying Signal-to-Noise and Distortion or SINAD. ENOB is defined as (SINAD - 1.76) / 6.02 and states that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.
FULL POWER BANDWIDTH is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.
GAIN ERROR is the deviation from the ideal slope of the transfer function. It can be calculated as:
Gain Error = Pos. Full-Scale Error - Neg. Full-Scale Error
INTEGRAL NON LINEARITY (INL) is a measure of the deviation of each individual code from a line drawn from negative full scale through positive full scale. The deviation of any given code from this straight line is measured from the center of that code value.
MISSING CODES are those output codes that will never appear at the ADC outputs. The ADC10040 is guaranteed not to have any missing codes.
NEGATIVE FULL SCALE ERROR is the difference between the input voltage ( $\mathrm{V}_{\mathrm{IN}^{+}}-\mathrm{V}_{\mathrm{IN}}$ ) just causing a transition from negative full scale to the first code and its ideal value of 0.5 LSB.

OFFSET ERROR is the input voltage that will cause a transition from a code of 0111111111 to a code of 1000000000.
OUTPUT DELAY is the time delay after the rising edge of the clock before the data update is presented at the output pins.

PIPELINE DELAY (LATENCY) is the number of clock cycles between initiation of conversion and when that data is presented to the output driver stage. Data for any given sample is available at the output pins the Pipeline Delay plus the Output Delay after the sample is taken. New data is available at every clock cycle, but the data lags the conversion by the pipeline delay.
POSITIVE FULL SCALE ERROR is the difference between the actual last code transition and its ideal value of $11 / 2$ LSB below positive full scale.
SIGNAL TO NOISE RATIO (SNR) is the ratio, expressed in $d B$, of the rms value of the input signal to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or DC.
SIGNAL TO NOISE PLUS DISTORTION (S/N+D or SINAD) Is the ratio, expressed in dB , of the rms value of the input signal to the rms value of all of the other spectral components below half the clock frequency, including harmonics but excluding d.c.
SPURIOUS FREE DYNAMIC RANGE (SFDR) is the difference, expressed in dB, between the rms values of the input signal and the peak spurious signal, where a spurious signal is any signal present in the output spectrum that is not present at the input.
TOTAL HARMONIC DISTORTION (THD) is the ratio, expressed in dBc , of the rms total of the first six harmonic levels at the output to the level of the fundamental at the output. THD is calculated as:

$$
T H D=20 \times \log \sqrt{\frac{f_{2}{ }^{2}+\ldots+f_{10}{ }^{2}}{f_{1}{ }^{2}}}
$$

where $f_{1}$ is the RMS power of the fundamental (output) frequency and $f_{2}$ through $f_{6}$ are the RMS power in the first 6 harmonic frequencies.
SECOND HARMONIC DISTORTION (2ND HARM) is the difference expressed in dB , between the RMS power in the input frequency at the output and the power in its 2nd harmonic level at the output.
THIRD HARMONIC DISTORTION (3RD HARM) is the difference, expressed in dB, between the RMS power in the input frequency at the output and the power in its 3rd harmonic level at the output.

## Timing Diagram



## Transfer Characteristics



FIGURE 2. Input vs. Output Transfer Characteristic

Typical Performance Characteristics Unless otherwise specified, the following specifications apply: $\mathrm{V}_{\mathrm{SSA}}=\mathrm{V}_{\mathrm{SSIO}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDA}}=+3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDIO}}=+2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=2 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}, \mathrm{STBY}=0 \mathrm{~V}$, External $\mathrm{V}_{\text {REF }}=1.2 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN}}=19 \mathrm{MHz}$, 50\% Duty Cycle.

DNL


20077812
DNL vs. Clock Duty Cycle (DC input)


20077813
INL


20077814

DNL vs. $\mathrm{f}_{\text {cLK }}$


20077815
DNL vs. Temperature


20077816
INL vs. $\boldsymbol{f}_{\text {cLK }}$


20077818


20077820
INL vs. Temperature


SNR vs. $V_{\text {DDIO }}$


20077819
SNR vs. $\mathbf{f}_{\text {CLK }}$


20077821
SNR vs. Clock Duty Cycle


20077823

SNR vs. Temperature


20077824


20077826
SNR vs. IRS


THD vs. $\mathrm{V}_{\text {DDA }}$


20077825
THD vs. $f_{\text {cLK }}$


20077827
THD vs. IRS


20077829



20077836
SINAD vs. IRS


20077838
SFDR vs. $V_{\text {DDA }}$


SFDR vs. $\mathbf{V}_{\text {DDIO }}$


20077837
SFDR vs. $\mathrm{f}_{\mathbf{c L K}}$


20077839
SFDR vs. IRS


20077841


20077842
SFDR vs. Temperature


20077844


20077843
Spectral Response @ 19 MHz Input


## Functional Description

The ADC10040 uses a pipeline architecture and has error correction circuitry to help ensure maximum performance. Differential analog input signals are digitized to 10 bits. In differential mode, each analog input signal should have a peak-to-peak voltage equal to $1.0 \mathrm{~V}, 0.75 \mathrm{~V}$ or 0.5 V , depending on the state of the IRS pin (pin 5), and be centered around $\mathrm{V}_{\mathrm{CM}}$ and be $180^{\circ}$ out of phase with each other. If single ended operation is desired, $\mathrm{V}_{\mathrm{IN}^{-}}$may be tied to the $\mathrm{V}_{\text {COM }}$ pin (pin 4). A single ended input signal may then be applied to $\mathrm{V}_{\mathrm{IN}^{+}}$, and should have an average value in the range of $\mathrm{V}_{\mathrm{CM}}$. The signal amplitude should be $2.0 \mathrm{~V}, 1.5 \mathrm{~V}$ or 1.0 V peak-to-peak, depending on the state or the IRS pin (pin 5).

## Applications Information

### 1.0 ANALOG INPUTS

The ADC10040 has two analog signal inputs, $\mathrm{V}_{\mathrm{IN}^{+}}$and $\mathrm{V}_{\mathrm{IN}^{-}}$. These two pins form a differential input pair. There is one common mode pin $\mathrm{V}_{\text {COM }}$ that may be used to set the common mode input voltage.

### 1.1 REFERENCE PINS

The ADC10040 is designed to operate with an internal or external 1.2 V reference. The internal 1.2 V reference is the defualt condition. If an external voltage is applied to the $\mathrm{V}_{\text {REF }}$ pin, then that voltage is used for the reference. The $V_{\text {REF }}$ pin should be bypassed to ground with a $0.1 \mu \mathrm{~F}$ capacitor placed close to the pin. Do not load this pin when using the internal reference.
The voltages at $\mathrm{V}_{\text {COM }}, \mathrm{V}_{\text {REFT }}$, and $\mathrm{V}_{\text {REFB }}$ are derived from the reference voltage. These pins are made available for bypass purposes only. These pins should each be bypassed to ground with a $0.1 \mu \mathrm{~F}$ capacitor placed close to the pin. It is very important that all grounds associated with the reference voltage and the input signal make connection to the analog ground plane at a single point to minimize the effects of noise currents in the ground path. DO NOT LOAD these pins.

## $1.2 \mathrm{~V}_{\text {com }}$ PIN

This pin supplies a voltage for possible use to set the common mode input voltage. This pin may also be connected to $\mathrm{V}_{1 \mathrm{IN}^{-}}$, so that $\mathrm{V}_{\mathrm{IN}}+$ may be used as a single ended input. These pins should be bypassed with at least a 0.1 uF capacitor. Do not load this pin.

### 1.3 SIGNAL INPUTS

The signal inputs are $\mathrm{V}_{\mathbb{I N}^{+}}$and $\mathrm{V}_{\mathbb{I N}^{-}}$. The input signal amplitude is defined as $\mathrm{V}_{\mathrm{IN}^{+}}-\mathrm{V}_{\mathrm{IN}^{-}}$and is represented schematically in Figure 3:


FIGURE 3. Input Voltage Waveforms for a $2 \mathrm{~V}_{\text {P-P }}$ differential Input


FIGURE 4. Input Voltage Waveform for a $\mathbf{2} \mathrm{V}_{\text {p-p }}$ Single Ended Input

A single ended input signal is shown in Figure 4.
The internal switching action at the analog inputs causes energy to be output from the input pins. As the driving source tries to compensate for this, it adds noise to the signal. To minimize the effects of this, use $18 \Omega$ series resistors at each of the signal inputs with a 25 pF capacitor across the inputs, as shown in Figure 5. These components should be placed close to the ADC because the input pins of the ADC is the most sensitive part of the system and this is the last opportunity to filter the input. The two $16 \Omega$ resistors and the 24 pF capacitor, together with the 4 pF ADC input capacitance, form a low-pass filter with a -3 dB frequency of 177 MHz .

### 1.4 CLK PIN

The CLK signal controls the timing of the sampling process. Drive the clock input with a stable, low jitter clock signal in the frequency range indicated in the AC Electrical Characteristics Table with rise and fall times of less than 2 ns . The trace carrying the clock signal should be as short as possible and should not cross any other signal line, analog or digital, not even at $90^{\circ}$. The CLK signal also drives an internal state machine. If the CLK is interrupted, or its frequency is too low, the charge on internal capacitors can dissipate to the point where the accuracy of the output data will degrade. This is what limits the lowest sample rate. The duty cycle of the clock signal can affect the performance of any A/D Converter. Because achieving a precise duty cycle is difficult, the ADC10040 is designed to maintain performance over a range of duty cycles. While it is specified and performance is guaranteed with a $50 \%$ clock duty cycle, performance is typically maintained with minimum clock low and high times indicated in the AC Electrical Characteristics Table. Both minimum high and low times may not be held simultaneously.

### 1.5 STBY PIN

The STBY pin, when high, holds the ADC10040 in a powerdown mode to conserve power when the converter is not being used. The power consumption in this state is 13.5 mW . The output data pins are undefined in this mode. Power consumption during power-down is not affected by the clock frequency, or by whether there is a clock signal present. The data in the pipeline is corrupted while in the power down.

### 1.6 DF PIN

The DF (Data Format) pin, when high, forces the ADC10040 to output the 2's complement data format. When DF is tied low, the output format is offset binary.

### 1.7 IRS PIN

The IRS (Input Range Select) pin defines the input signal amplitude that will produce a full scale output. The table below describes the function of the IRS pin.

TABLE 1. IRS Pin Functions

| IRS Pin | Full-Scale Input |
| :---: | :---: |
| $\mathrm{V}_{\text {DDA }}$ | $2.0 \mathrm{~V}_{\text {P-P }}$ |
| $\mathrm{V}_{\text {SSA }}$ | $1.5 \mathrm{~V}_{\text {P-P }}$ |
| Floating | $1.0 \mathrm{~V}_{\text {P-P }}$ |

### 1.8 OUTPUT PINS

The ADC10040 has 10 TTL/CMOS compatible Data Output pins. The offset binary data is present at these outputs while the DF and STBY pins are low. Be very careful when driving a high capacitance bus. The more capacitance the output drivers must charge for each conversion, the more instanta-
neous digital current flows through $\mathrm{V}_{\text {DDIO }}$ and $\mathrm{V}_{\text {SSIO }}$. These large charging current spikes can cause on-chip noise and couple into the analog circuitry, degrading dynamic performance. Adequate bypassing, limiting output capacitance and careful attention to the ground plane will reduce this problem. Additionally, bus capacitance beyond the specified $10 \mathrm{pF} / \mathrm{pin}$ will cause $\mathrm{t}_{\mathrm{OD}}$ to increase, making it difficult to properly latch the ADC output data. The result could be an apparent reduction in dynamic performance. To minimize noise due to output switching, minimize the load currents at the digital outputs. This can be done by minimizing load capacitance and by connecting buffers between the ADC outputs and any other circuitry, which will isolate the outputs from trace and other circuit capacitances and limit the output currents, which could otherwise result in performance degradation. Only one driven input should be connected to the ADC output pins.
While the $t_{O D}$ time provides information about output timing, a simple way to capture a valid output is to latch the data on the rising edge of the conversion clock.

### 1.9 APPLICATION SCHEMATICS

The following figures show simple examples of using the ADC10040. The ADC10040 performs best with a differential input signal.

### 1.9.1 Narrow Band A.C. Signals

Figure 5 shows a typical circuit for an AC coupled, differentially driven input. The $16 \Omega$ resistors and 24 pF capacitor, together with the 4 pF input capacitance of the ADC10040, provides a -3dB input bandwidth of 177 MHz , while the $0.1 \mu \mathrm{~F}$ capacitor at $\mathrm{V}_{\text {COM }}$ stabilizes the common move voltage at the transformer center tap.


FIGURE 5．A Simple Application Using a Differential Signal Source

## 1．9．2 D．C．Applications

For very low frequency and DC input applications，a d．c．cou－ pled amplifier or buffer may be needed，especially when the input is single－ended and the advantages of a differential input signal is desired．Figure 6 shows the input drive circuit that can be used to replace the transformer of Figure 5．The LMH6550 provides excellent performance and is well－suited for this application．The common mode output voltage of the LMH6550 is the same as its VCM input．


20077851
FIGURE 6．Using the LMH6550 for DC and wideband applications

## 1．9．3 Single Ended Applications

Performance of the ADC10040 with a single－ended input is not as good as its performance with a differential input．How－ ever，if the lower performance is adequate，the circuit of Figure 7 shows an acceptable method of driving the analog input．


FIGURE 7. A Simple Application Using a Single Ended Signal Source

Physical Dimensions inches (millimeters) unless otherwise noted


## Notes

ADC10040/ADC10040Q 10-Bit, 40 MSPS, 3V, 55 mW A/D Converter

## Notes

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